

HI-4853, 4854, 4855

High-Speed 3.0V to 5.5V, Slew-Rate Controlled RS-485/422
Transceivers with Extended Common-Mode Range

GENERAL DESCRIPTION

The HI-485x devices are high-speed slew-rated controlled TIA-485/TIA-422-B and ISO 8482:1993 compliant transceivers with extended receiver common-mode range for avionic and industrial control applications. The devices can operate over an extended supply (3.0V to 5.5V) and temperature (-55°C to 125°C) range. The receiver input common-mode range of [-15, 20]V and ±24V for the half and full duplex configurations respectively, is valid over the full supply and temperature specification. The HI-4853 has a half-duplex configuration, and the HI-4854 and HI-4855 are full-duplex. Slew rates are optimized for data rates below 25Mbps. The drivers slew-rate control and pre-emphasis reduces high-frequency components in the output signal transitions and also compensates for impedance mismatch. These features provide optimum EMI and jitter performance, essential in EMI sensitive environments and high-integrity data link applications such as in aerospace and industrial controls.

The devices deliver at least ± 1.50V (VDD=3.0V), and ± 2.45V (VDD= 4.5V) output levels at an extended temperature range of -55°C to +125°C into a differential load of 54Ω and 50pF.

The receiver offers true Fail-Safe operation, providing a guaranteed logic high on RO when the bus is open-circuit, short-circuit, or idle (terminated but not driven). The receiver's worst case minimum input resistance is at least 90KΩ, supporting up to 224 nodes.

APPLICATIONS

- Extended Temperature Range RS-485/422 Networks
- Process Control and Factory Automation
- EMI Emission Sensitive Avionics
- Industrial Field Bus Networks
- Networks requiring extended common-mode range
- Miniature Munitions Stores Interface (MMSI / EBR-1553)

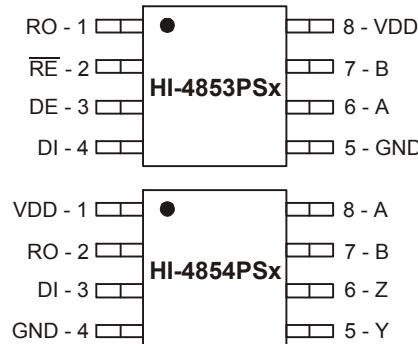
| Device Selection Table | | | |
|------------------------|------------------|-------------------|---------------------------|
| Part Number | Half/Full Duplex | Data Rate (Mbps)* | Package |
| HI-4853 | Half | ≤ 20.0 | 8-pin SOIC |
| HI-4854 | Full | ≤ 20.0 | 8-pin SOIC |
| HI-4855 | Full | ≤ 20.0 | 14-pin SOIC 16-pin QFN |

* For RS-485 Transceivers optimized for data rates up to 5Mbps please refer to the HI-4850 data sheet.

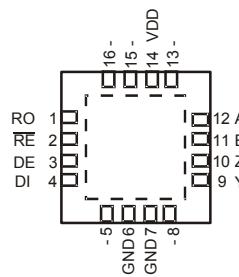
FEATURES

- Slew Rate Control and Pre-Emphasis for superior EMI
- Extended Power Supply Operating Range 3.0V to 5.5V
- Extended Receiver Common-Mode Range:
 - **-15.0V to 20.0V Half-Duplex**
 - **±24V Full-Duplex**
- ESD Protection
 - ±16KV HBM (Bus Pins)
 - ±8KV HBM (Logic Pins)
- 20 Mbps Data Rate up to 100 ft. CAT-5 UTP
- 12 Mbps Data Rate up to 1000 ft. CAT-5 UTP
- Current Limiting Protection
- Extended Temperature Range -55°C to 125°C
- Industry Standard 75176 Pin-out

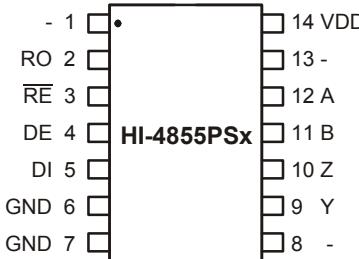
PIN CONFIGURATIONS (Top Views)



8-Pin Plastic SOIC package (Narrow Body)



HI-4855PCx
16- pin 4mm x 4mm QFN



14-Pin Plastic SOIC package (Narrow Body)

PIN DESCRIPTIONS

| SIGNAL | FUNCTION | DESCRIPTION |
|-----------------|------------|--|
| RO | OUTPUT | Receiver Output. If $V_{ID} \geq -50mV$, then RO is high. If $V_{ID} < -150mV$ then RO is low. If the bus is shorted, open or terminated but not driven by another terminal, RO will be high. |
| \overline{RE} | INPUT | Receiver Enable. \overline{RE} = Low enables the receiver. \overline{RE} High forces the receiver output (RO) into a high impedance state. Internal 450KΩ pull-down resistor |
| DE | INPUT | Driver Enable. DE = high enables the driver. DE = low will force the driver output into a high impedance state and the device will function as a line receiver if \overline{RE} is also low. Internal 450KΩ pull-up resistor |
| DI | INPUT | Driver Input. Forces the logic state of the Driver's output, if Driver is enabled. Internal 450KΩ pull-up resistor |
| GND | POWER | Chip ground, 0V Supply |
| A, Y | ANALOG I/O | Non-inverting Receiver Input / Driver Output. |
| B, Z | ANALOG I/O | Inverting Receiver Input / Driver Output. |
| VDD | POWER | Positive Supply: $3.0V \leq VDD \leq 5.5V$ |

TX FUNCTION TABLE

| TRANSMITTING | | | | |
|-----------------|----|----------------|---------------------|-----------|
| INPUTS | | LINE CONDITION | OUTPUTS | |
| \overline{RE} | DE | DI | B | A |
| X | 1 | 1 | Transmit logic high | 0 1 |
| X | 1 | 0 | Transmit logic low | 1 0 |
| 0 | 0 | X | Disable | Hi-Z Hi-Z |
| 1 | 0 | X | Shutdown | Hi-Z Hi-Z |

RX FUNCTION TABLE

| RECEIVING | | | | |
|-----------------|----|----------------------------------|--------------|---------------------|
| INPUTS | | BUS PINS $V_{ID} = V_A - V_B$ | OUTPUT RO | OPERATION |
| \overline{RE} | DE | | | |
| 0 | 0 | $-150mV < V_{ID} < -50mV$ | X | Undefined Input |
| 0 | X | $-50mV \leq V_{ID}$ | 1 | Receiver logic high |
| 0 | X | $V_{ID} \leq -150mV$ | 0 | Receiver logic low |
| 0 | 0 | Open or Shorted | 1 | Default |
| 0 | 0 | Idle and terminated | 1 | Default |
| 1 | 1 | X | Hi-Z | Disabled |
| 1 | 0 | X | Hi-Z | Shutdown |

Typical Operating Circuit

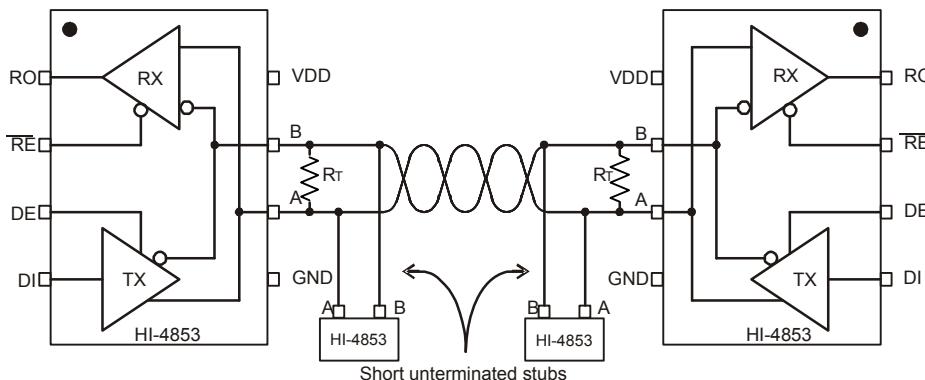


Figure 1 - Typical half-duplex configuration

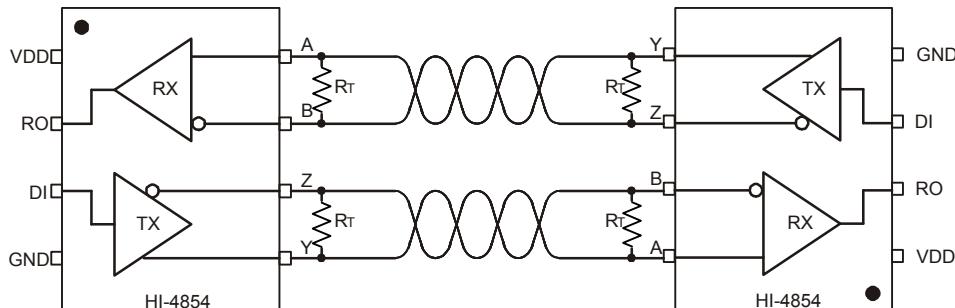


Figure 2 - Typical full-duplex 8-pin configuration

ABSOLUTE MAXIMUM RATINGS

(Voltages referenced to GND = 0V)

| | | | |
|---|---------------------|---|-----------------|
| Supply Voltage, VDD:..... | 7 V | Operating Temperature Range:(Industrial)..... | -40°C to +85°C |
| Control Input Currents: | -100mA to 100mA | (Hi-Temp)..... | -55°C to +125°C |
| Digital Input Voltages (DI, DE, RE): | -0.5V to VDD + 0.5V | | |
| Bus Voltage (AY, BZ): | ±25V | Internal Power Dissipation:..... | 900mW |
| Digital Output Voltage (RO):..... | -0.5V to V + 0.5V | Storage Temperature Range: | -65°C to +150°C |
| Short-Circuit Duration, Driver (V: ±15V)..... | ∞ | | |
| ESD (Human Body Model): | | Solder Temperature: (Reflow)..... | 260°C |
| AY, BZ,VDD,GND pins:..... | ±16KV | | |
| DI, DE, RE, RO pins:..... | ±8KV | | |

NOTE: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only. Functional operation of the device at these or any other conditions above those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

SPECIFIED OPERATING CONDITIONS

| PARAMETERS | SYMBOL | CONDITIONS | LIMITS | | | UNIT |
|---------------------------------|------------------|---|--------|-----------|-----|------------------|
| | | | MIN | TYP | MAX | |
| Supply Voltage | V _{DD} | | 3.0 | 3.3 / 5.0 | 5.5 | V |
| Temperature | T | | -55 | | 125 | °C |
| TX Common-Mode Bus Loading | V _{OCM} | See Figure 4 | -7 | | 12 | V |
| RX Input Common-Mode Voltage | V _{ICM} | Half-Duplex | -16 | | 20 | V |
| Differential Load Resistance | R _L | | 54 | 60 | ∞ | Ω |
| Differential Load Capacitance | C _L | | | 100 | | pF |
| Digital Input High Voltage | V _{IH} | DE, DI, RE | 70 | | | %V _{DD} |
| Digital Input Low Voltage | V _{IL} | DE, DI, RE | | | 30 | %V _{DD} |
| Digital Input Current high | I _{IH} | DE, DI, V _{IH} = V _{DD} | | | 1 | μA |
| Digital Input Pull-Down Current | I _{PD} | RE, V _{IH} = V _{DD} | 6 | | 18 | μA |
| Digital Input Current low | I _{IL} | RE, V _{IH} = 0 | -1 | | | μA |
| Digital Input Pull-Up Current | I _{PU} | DE, DI, V _{IH} = 0V | -18 | | -6 | μA |

DRIVER DC ELECTRICAL CHARACTERISTICS

VDD = 3.0V to 3.6V or 4.5V to 5.5V; T = -55°C to 125°C; MIN and MAX values are at range boundaries

| PARAMETER | SYMBOL | CONDITIONS | FIGURE | VDD = 3.3V ± 10% | | | VDD = 5.0V ± 10% | | | UNIT |
|--|-------------------|---|--------|----------------------|------|-----------------|----------------------|------|-----------------|------------------|
| | | | | MIN | TYP | MAX | MIN | TYP | MAX | |
| Differential Output Voltage with no load | V _{OD1} | R _L = ∞ | 3 | V _{DD} -0.1 | | V _{DD} | V _{DD} -0.1 | | V _{DD} | V |
| Differential Output Voltage into load with no common-mode voltage | V _{OD2} | R _L = 54Ω, C _L = 50pF | 3 | 1.5 | | 3.0 | 2.45 | | 4.0 | V |
| Differential Output Voltage into load with applied common-mode voltage | V _{OD3} | -7V ≤ V _{OCM} ≤ 12V T _A = 25°C | 4 | 1.5 | | 3.0 | 2.45 | | 4.0 | V |
| Differential Output Over/Under Shoot | | | | | | 5.5 | | | 3.2 | %V _{OD} |
| Change in Differential Output Voltage between logic states | ΔV _{OD} | R _L = 54Ω, C _L = 50pF | 3 | -125 | | 125 | -125 | | 125 | mV |
| Output Common-Mode Voltage | V _{OCM} | R _L = 54Ω, C _L = 50pF | 4 | 1.40 | 1.60 | 2.0 | 2.15 | 2.45 | 3.0 | V |
| Change in output Common-Mode Voltage between logic states | ΔV _{OCM} | R _L = 54Ω, C _L = 50pF | 4 | -125 | | 125 | -150 | | 150 | mV |
| Bus Pin Leakage Current (High-Z Power On) | I _{OHZ1} | DE=0, -15V ≤ VOCM ≤ 15V DE=0, -12V ≤ VOCM ≤ 15V | | -200 | | 200 | -200 | | 200 | μA |
| Bus Pin Leakage Current (Power Off) | I _{OHZ2} | V _{OCM} = ±15V | | -200 | | 200 | -200 | | 200 | μA |
| Peak Short Circuit Current | I _{SCPK} | DE = V _{DD} , Bus Pin = ±15 | | -230 | | 230 | -250 | | 250 | mA |
| Steady State Short Circuit Current | I _{SC} | DE = V _{DD} , Bus Pin = ±15 | | 0 | | 50 | 0 | | 50 | μA |
| Differential Output Capacitance | C _{OD} | DE = 0 | | | | 16 | | | 16 | pF |
| Static Supply Current | I _{DD} | DE=V _{DD} , RE=0, R _L =∞ | | | 8 | 10 | | 10 | 12 | mA |
| Supply Current (Shutdown) | I _{DDQ} | DE=0, RE=V _{DD} , R _L =∞ | | | 90 | 110 | | 125 | 400 | μA |

DRIVER SWITCHING CHARACTERISTICS

VDD = 3.0V - 3.6V or 4.5V - 5.5V as noted , Operating temperature range.

| PARAMETER | SYMBOL | CONDITIONS | FIGURE | VDD = 3.3V ± 10% | | | VDD = 5.0V ± 10% | | | UNIT |
|-----------------------------------|------------------|--|--------|------------------|-----|-----|------------------|-----|-----|------|
| | | | | MIN | TYP | MAX | MIN | TYP | MAX | |
| Propagation Delay Low - to - High | t _{PDR} | R _L = 54 _Z , C _L =50pF | 5 & 6 | 17 | 26 | 33 | 16 | 24 | 30 | ns |
| Propagation Delay High - to - Low | t _{PDF} | R _L = 54 _Z , C _L =50pF | 5 & 6 | 17 | 26 | 33 | 16 | 24 | 30 | ns |
| Differential Rise Time | t _r | R _L = 54 _Z , C _L =50pF | 5 & 6 | 9 | 12 | 15 | 8 | 11 | 16 | ns |
| Differential Fall Time | t _f | R _L = 54 _Z , C _L =50pF | 5 & 6 | 9 | 12 | 15 | 8 | 11 | 16 | ns |
| Output Pulse Skew | t _{MSK} | R _L = 54 _Z , C _L =50pF | 5 & 6 | | 2 | 8 | | 2 | 8 | ns |
| Driver Enable to Output High | t _{ZH} | R _L = 500 _Z , C _L =50pF | 7 | | 95 | 120 | | 90 | 117 | ns |
| Driver Enable to output Low | t _{ZL} | R _L = 500 _Z , C _L =50pF | 7 | | 95 | 120 | | 90 | 117 | ns |
| Driver Disable from Output High | t _{HZ} | R _L = 500 _Z , C _L =50pF | 7 | | 20 | 33 | | 18 | 30 | ns |
| Driver Disable from Output Low | t _{LZ} | R _L = 500 _Z , C _L =50pF | 7 | | 20 | 33 | | 18 | 30 | ns |
| Shutdown to Active Output Delay | t _{ON} | R _L = 500 _Z , C _L =50pF | 7 | | | 10 | | | 10 | μs |
| Shutdown Delay | t _{OFF} | | | | | 10 | | | 10 | μs |

RECEIVER DC ELECTRICAL CHARACTERISTICS

VDD = 3.0V - 3.6V or 4.5V - 5.5V as noted , Operating temperature range.

| PARAMETER | SYMBOL | CONDITIONS | FIGURE | VDD = 3.3V ± 10% | | | VDD = 5.0V ± 10% | | | UNIT |
|--------------------------------------|------------------|--|--------|------------------|------|-----|------------------|------|-----|-----------------|
| | | | | MIN | TYP | MAX | MIN | TYP | MAX | |
| Differential Input Threshold Voltage | V _{TH} | -15 ≤ V _{ICM} ≤ +20 | | -200 | -100 | -50 | -200 | -100 | -50 | mV |
| Input Hysteresis | V _{HYS} | V _{ICM} = 0V | | 17 | 28 | 33 | 17 | 28 | 33 | mV |
| Input Resistance | R _{IN} | -15 ≤ V _{ICM} ≤ +20 | | 80 | 92 | | 80 | 92 | | K _Z |
| RO Output High Level | V _{OH} | V _{ICM} = +200mV I _{OUT} = -3.0mA | | 90% | | | 90% | | | V _{DD} |
| RO Output Low Level | V _{OL} | V _{ICM} = -200mV I _{OUT} = +3.0mA | | | | 10% | | | 10% | V _{DD} |
| RO Output Hi-Z Leakage Current | I _{OZH} | 0V ≤ V _{RO} ≤ V _{DD} : | | -1 | | 1 | -1 | | 1 | μA |

RECEIVER SWITCHING CHARACTERISTICS

VDD = 3.0V - 3.6V or 4.5V - 5.5V as noted , Operating temperature range.

| PARAMETER | SYMBOL | CONDITIONS | FIGURE | VDD = 3.3V ± 10% | | | VDD = 5.0V ± 10% | | | UNIT |
|------------------------------------|-------------------|---|--------|------------------|-----|-----|------------------|-----|-----|------|
| | | | | MIN | TYP | MAX | MIN | TYP | MAX | |
| Propagation Delay Low - to - High | t _{RPDR} | V _{ID} = +1.5V, C _L =15pF | 8 | 20 | 26 | 32 | 20 | 26 | 32 | ns |
| Propagation Delay High - to - Low | t _{RPDF} | V _{ID} = -1.5V, C _L =15pF | 8 | 20 | 26 | 32 | 20 | 26 | 32 | ns |
| RO Output Rise Time | t _{Rr} | V _{ID} = +1.5V, C _L =15pF | 8 | 1.1 | 1.9 | 3.3 | 1.1 | 1.9 | 3.3 | ns |
| RO Output Fall Time | t _{Rf} | V _{ID} = -1.5V, C _L =15pF | 8 | 1.1 | 1.9 | 3.3 | 1.1 | 1.9 | 3.3 | ns |
| Output Pulse Skew | t _{RMSK} | V _{ID} = +1.5V, C _L =15pF | 8 | | 0.8 | 1.6 | | 0.8 | 1.6 | ns |
| Receiver Enable to RO Output High | t _{ZH} | R _L = 1K _Z , C _L =15pF | 9 | | 12 | 16 | | 12 | 16 | ns |
| Receiver Enable to output Low | t _{ZL} | R _L = 1K _Z , C _L =15pF | 9 | | 12 | 16 | | 12 | 16 | ns |
| Receiver Disable from Output High | t _{RHZ} | R _L = 1K _Z , C _L =15pF | 9 | | 6 | 10 | | 6 | 10 | ns |
| Receiver Disable from Output Low | t _{RLZ} | R _L = 1K _Z , C _L =15pF | 9 | | 6 | 10 | | 6 | 10 | ns |
| Shutdown to RO Active Output Delay | t _{RON} | R _L = 1K _Z , C _L =15pF | 9 | | | 5 | | | 5 | μs |
| Shutdown Delay to RO HiZ | t _{ROFF} | R _L = 1K _Z , C _L =15pF | 9 | | 60 | 100 | | 60 | 100 | ns |

TEST CIRCUITS

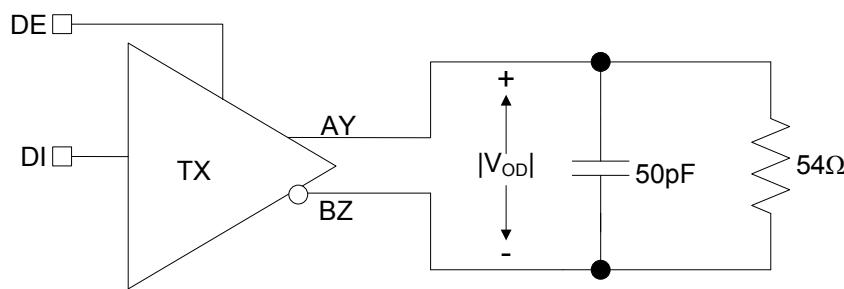


Figure 3 - Driver DC Characteristics (V_{OD1} , V_{OD2} , and ΔV_{OD})

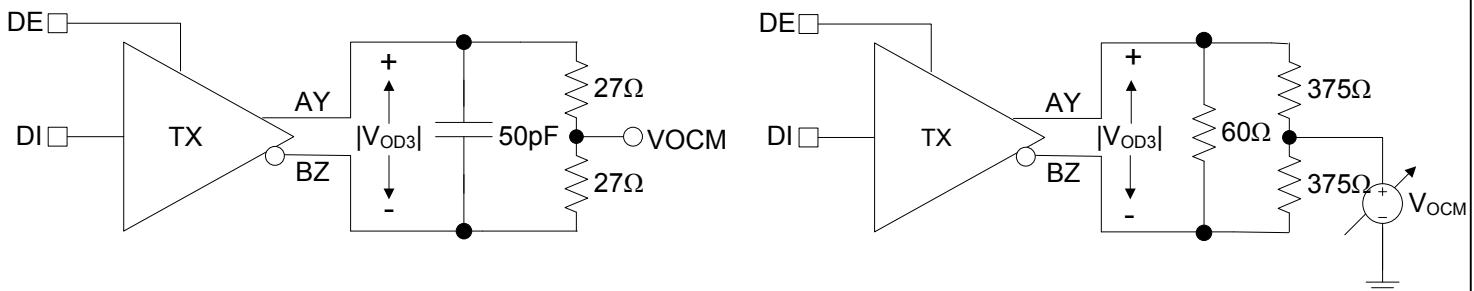


Figure 4 - Driver DC Characteristics with and without Common-Mode Loading (V_{OCM} , V_{OD3} , and ΔV_{OD})

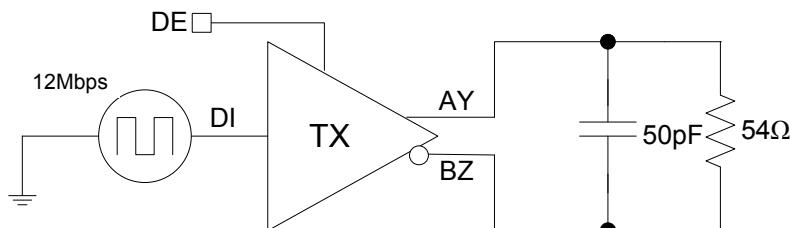


Figure 5 - Driver Switching Characteristics (t_{PDR} , t_{PDF} , t_r and t_f)

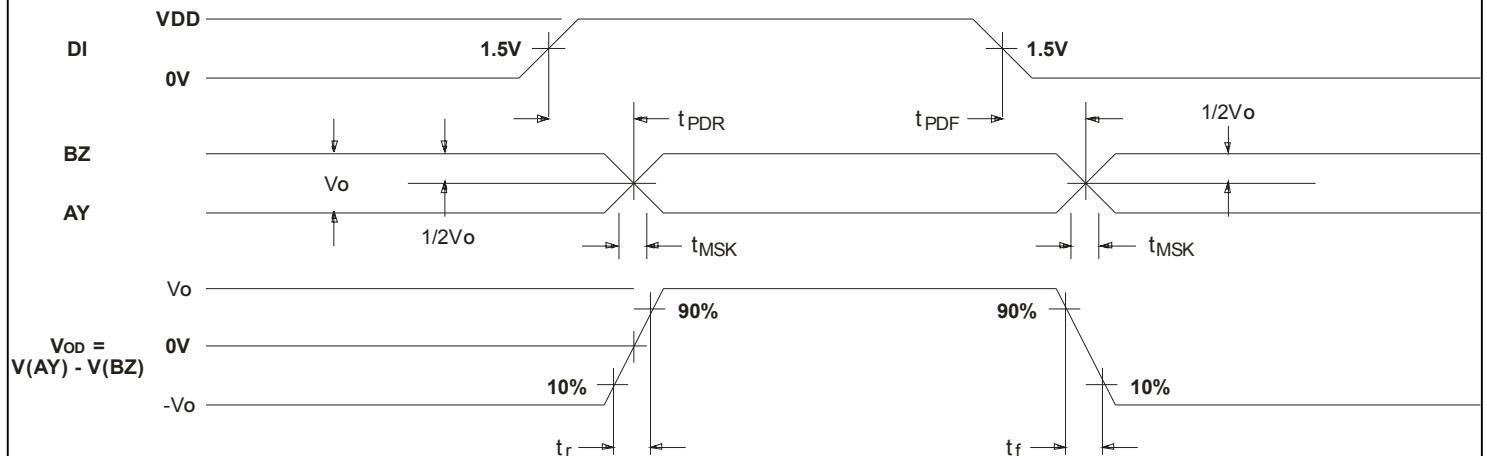


Figure 6. Driver Switching Waveforms

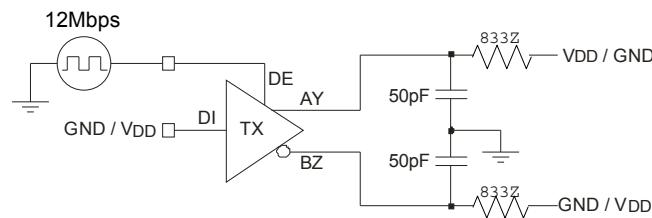


Figure 7. Driver Enable / Disable Switching

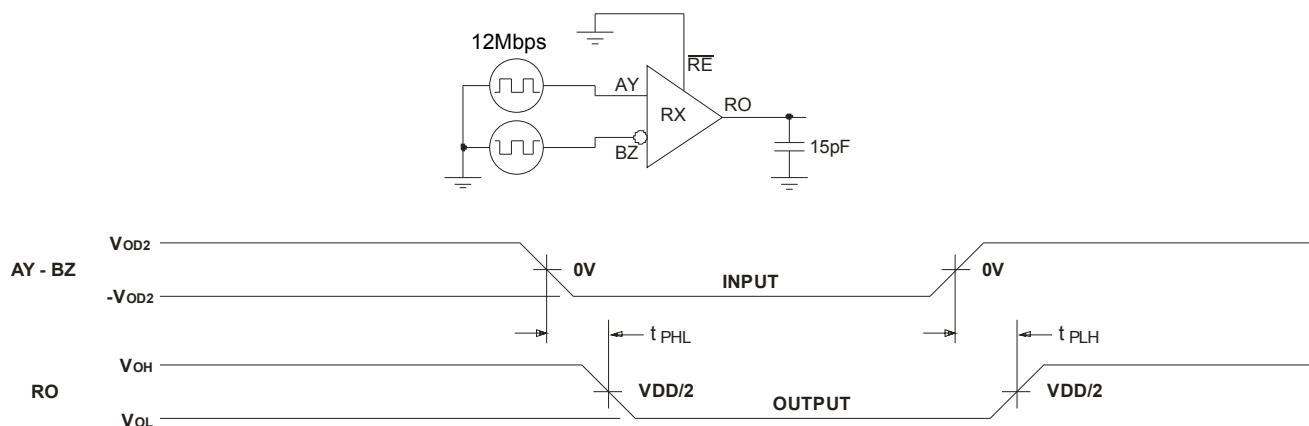


Figure 8. Receiver Propagation Delays

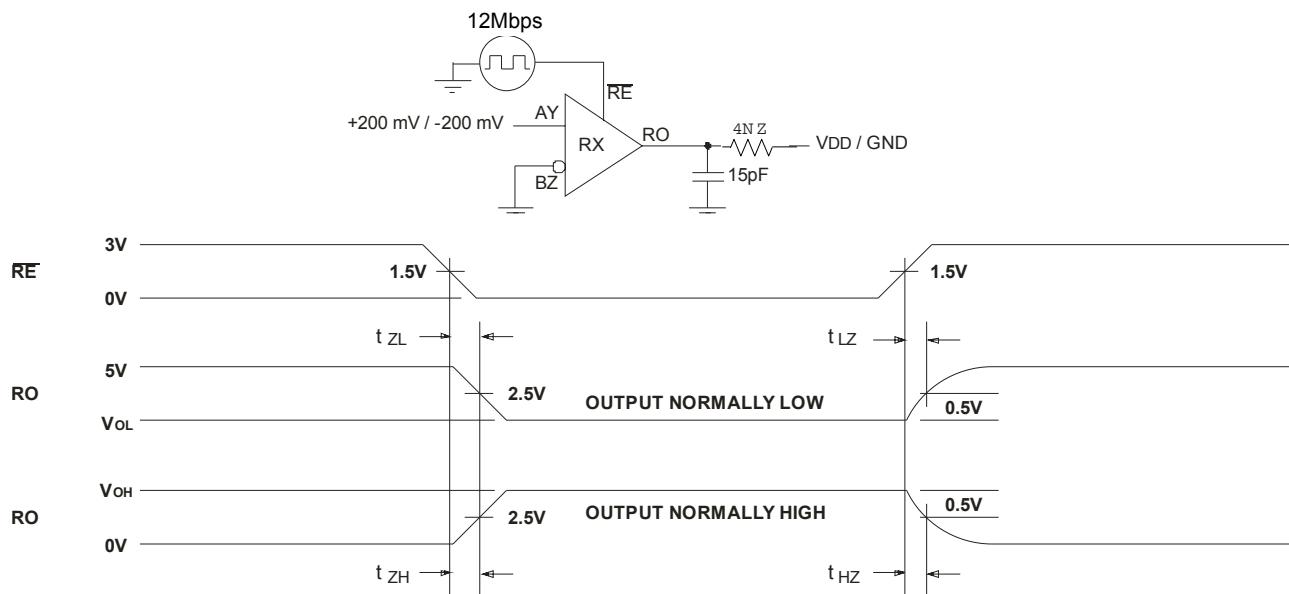
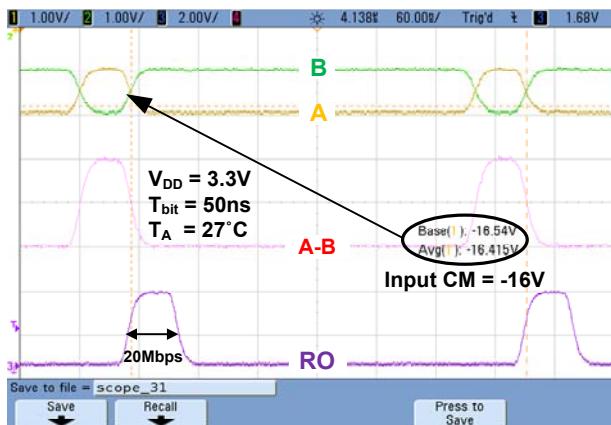


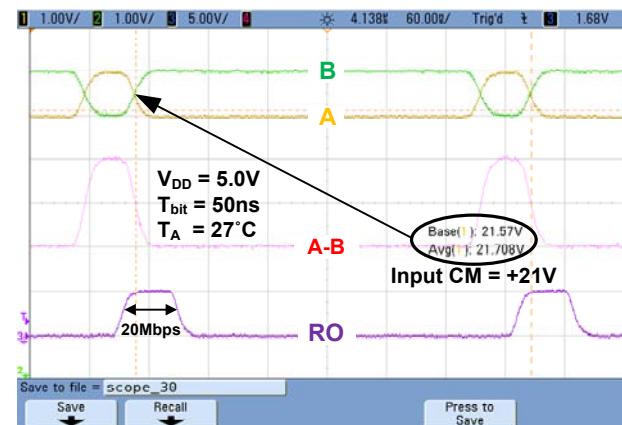
Figure 9. Receiver Enable and Disable Times

EXTENDED COMMON-MODE PERFORMANCE CHARACTERISTICS

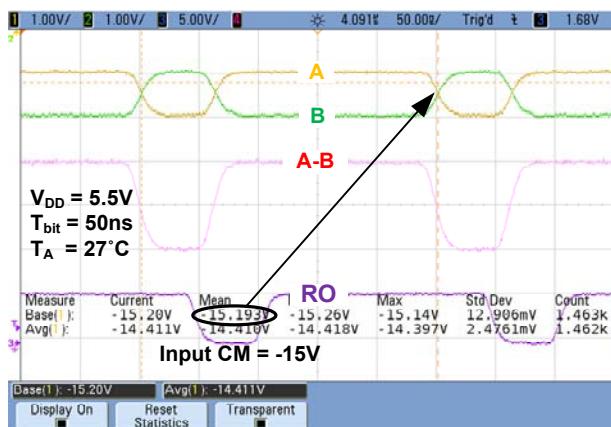
RX Extended Common-Mode Range:
Typical Supply, Maximum (-) Common-Mode



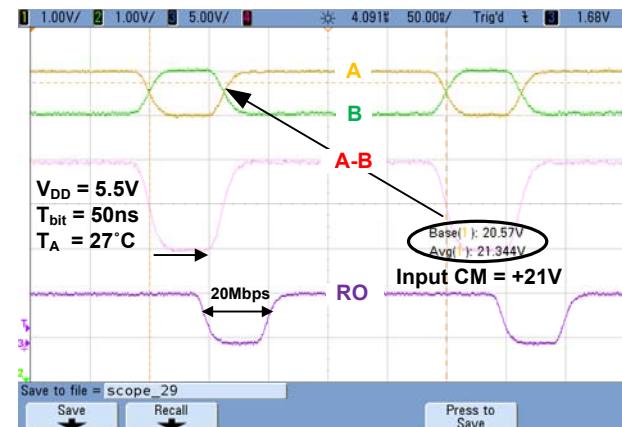
RX Extended Common-Mode Range:
Typical Supply, Maximum (+) Common-Mode



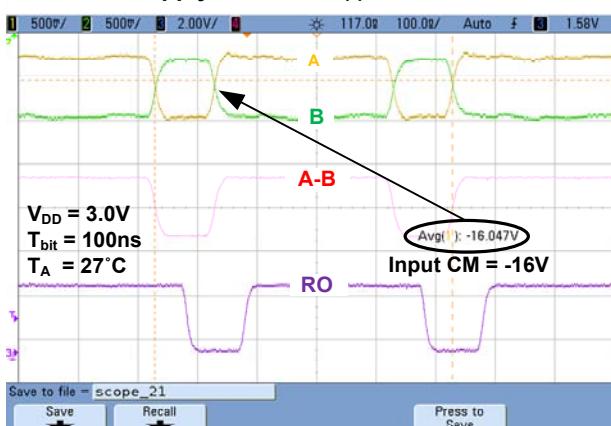
RX Extended Common-Mode Range:
Maximum Supply, Maximum (-) Common-Mode



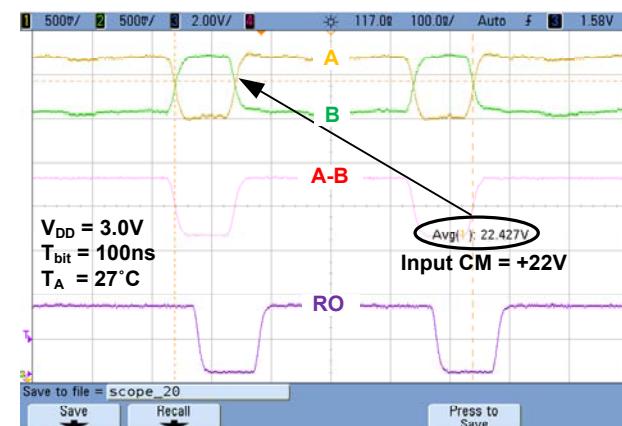
RX Extended Common-Mode Range:
Maximum Supply, Maximum (+) Common-Mode



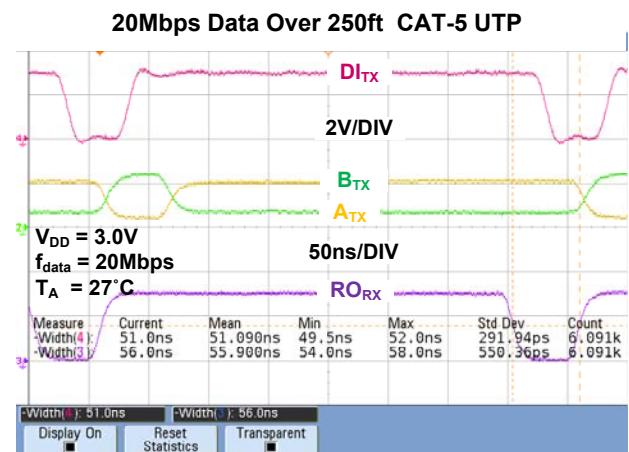
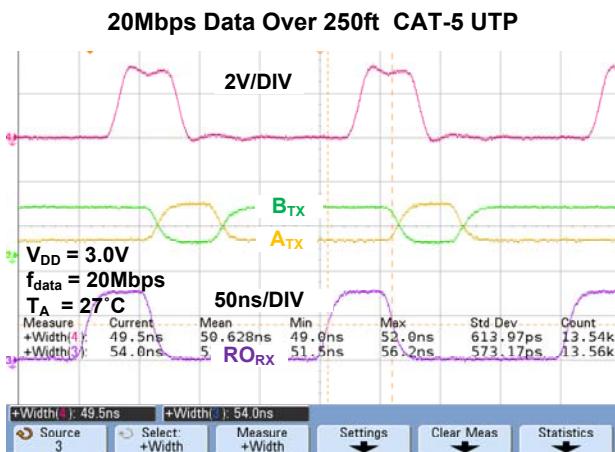
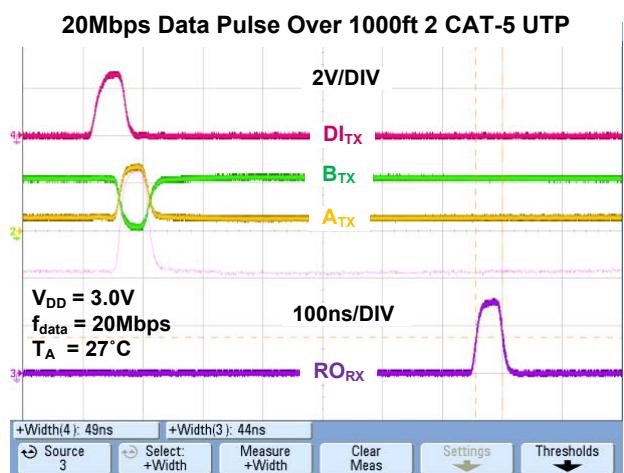
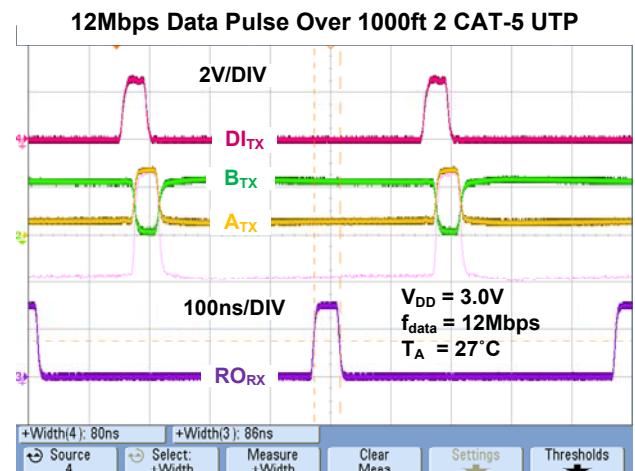
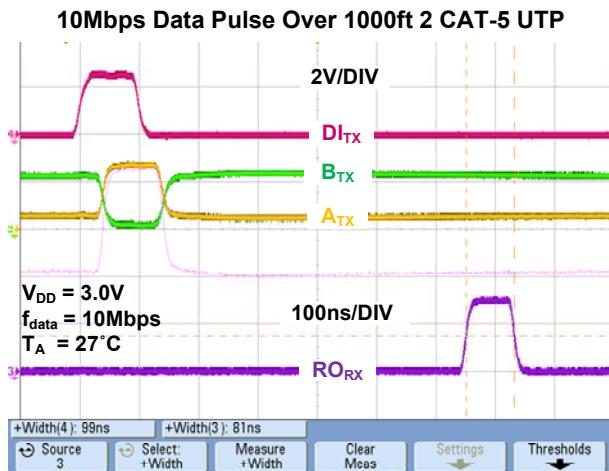
RX Extended Common-Mode Range:
Minimum Supply, Maximum (-) Common-Mode



RX Extended Common-Mode Range:
Minimum Supply, Maximum (+) Common-Mode

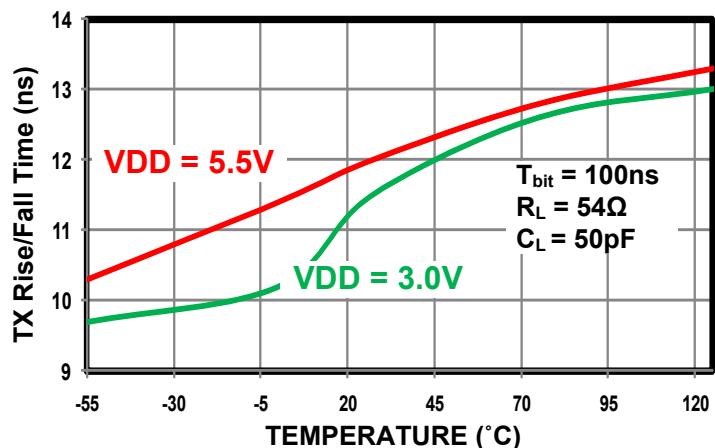


High-Speed Performance Characteristics Over Distance

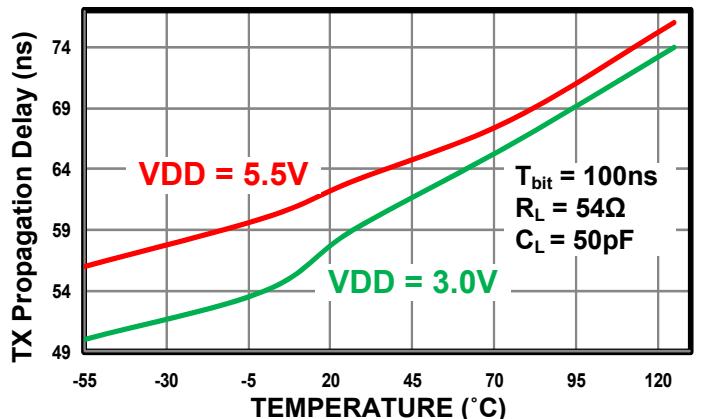


PERFORMANCE CHARACTERISTICS OVER SUPPLY AND TEMPERATURE

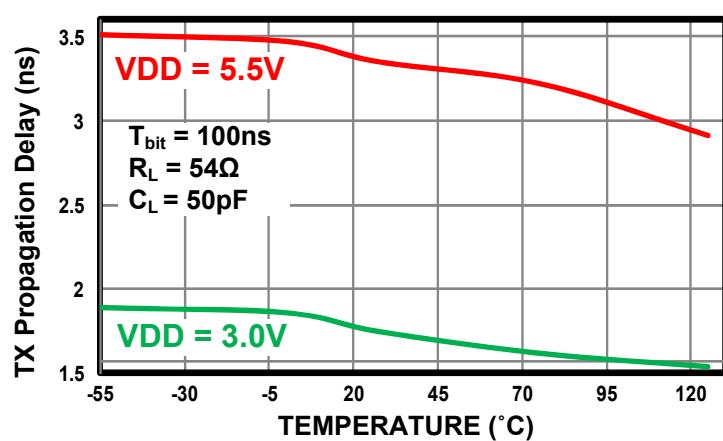
TX Differential Rise/Fall Time vs. Temperature



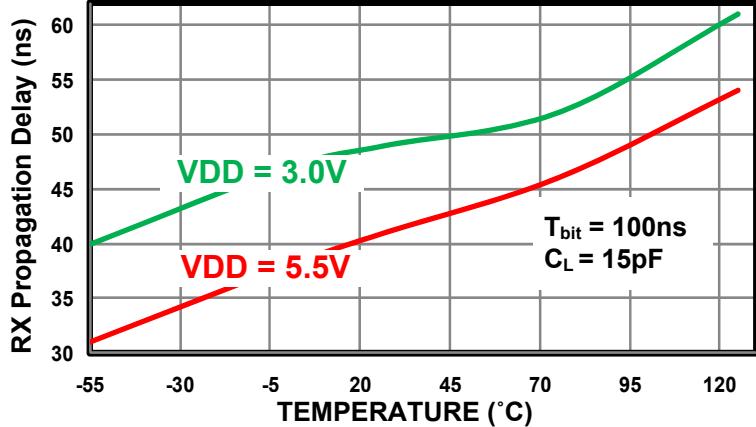
TX Differential Rise/Fall Time vs. Temperature



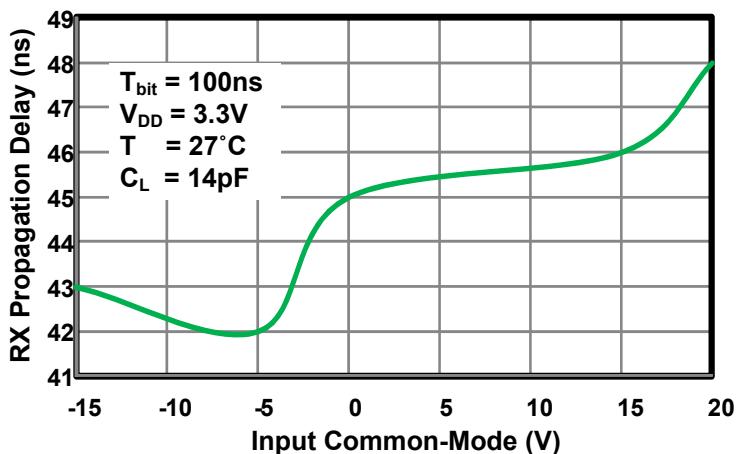
TX Differential Zero To Peak Amplitude



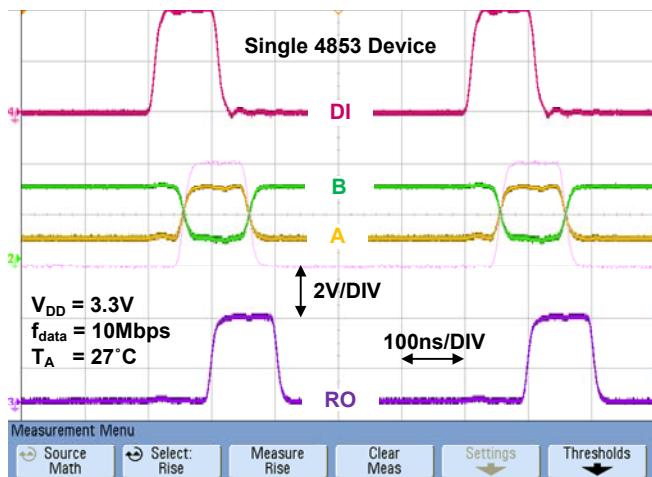
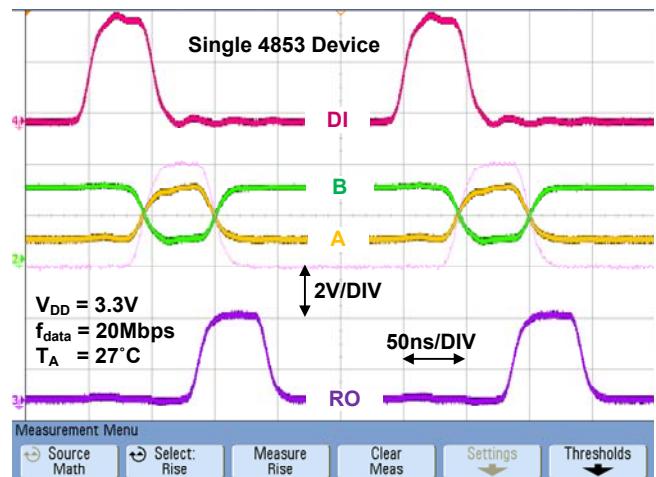
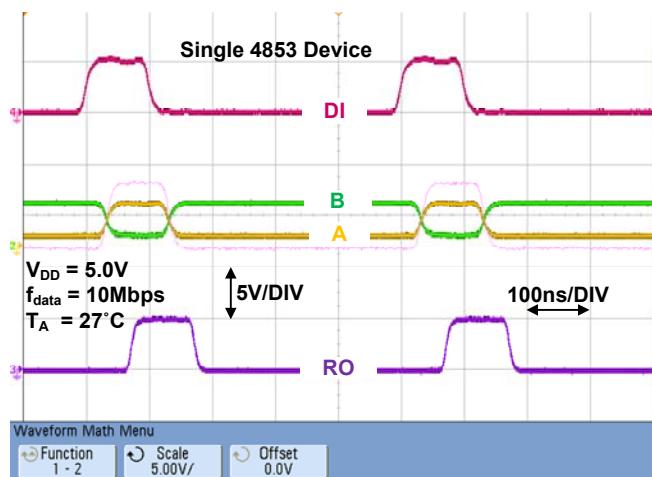
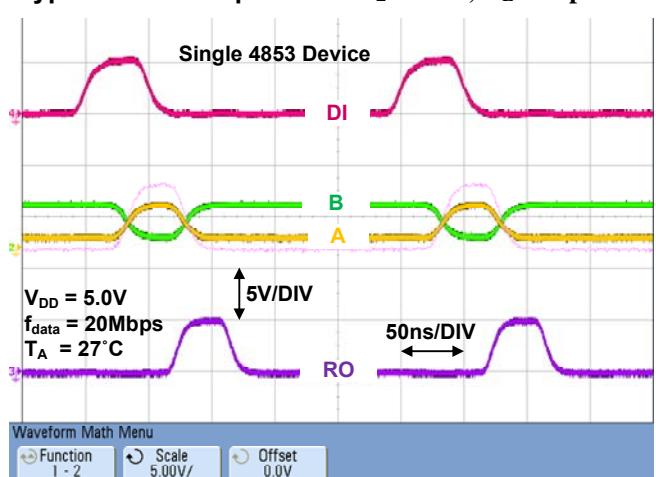
RX Propagation Delay vs. Temperature



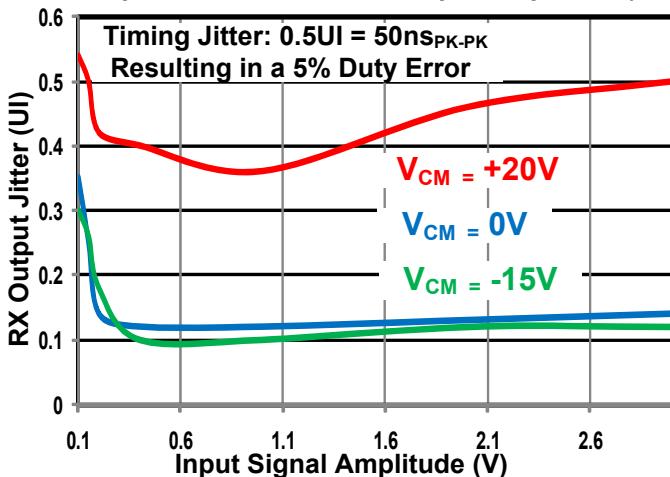
RX Propagation Delay vs. Common-Mode



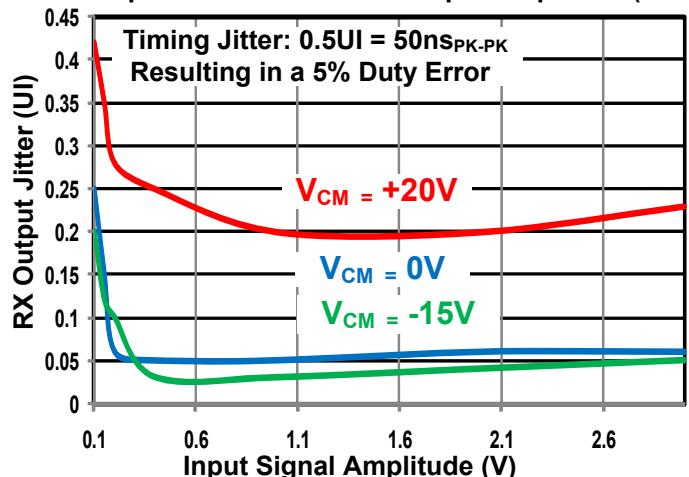
TYPICAL TRANSCEIVER PERFORMANCE CHARACTERISTICS

Typical 10Mb/s Operation: $R_L = 54\Omega$; $C_L = 50\text{pF}$ Typical 20Mb/s Operation: $R_L = 54\Omega$; $C_L = 50\text{pF}$ Typical 10Mb/s Operation: $R_L = 54\Omega$; $C_L = 50\text{pF}$ Typical 20Mb/s Operation: $R_L = 54\Omega$; $C_L = 50\text{pF}$ 

RX Output Jitter Over CM and Input Amplitude (5.5V)



RX Output Jitter Over CM and Input Amplitude (3.0V)



ORDERING INFORMATION

HI-485x XX X X

| PART NUMBER | LEAD FINISH | | |
|-------------|--|------|---------|
| Blank | Tin / Lead (Sn / Pb) Solder | | |
| F | 100% Matte Tin (Pb-free, RoHS compliant) | | |
| PART NUMBER | TEMPERATURE RANGE | FLOW | BURN IN |
| I | -40°C TO +85°C | I | NO |
| T | -55°C TO +125°C | T | NO |
| M | -55°C TO +125°C | M | YES |
| PART NUMBER | PACKAGE DESCRIPTION | | |
| PS | 8 PIN PLASTIC NARROW BODY SOIC (8HN) (HI-4853, HI-4854) | | |
| PS | 14 PIN PLASTIC NARROW BODY SOIC (14HN) (HI-4855 only) | | |
| CR | 8 PIN CERDIP (8D) not available Pb-free (HI-4853, HI-4854) | | |
| PART NUMBER | FUNCTION | | |
| 4853 | HALF DUPLEX TRANSCEIVER | | |
| 4854 | FULL DUPLEX TRANSCEIVER ALWAYS ENABLED | | |
| 4855 | FULL DUPLEX TRANSCEIVER WITH ENABLE PINS | | |

ORDERING INFORMATION

HI-4855 xx x x

| PART NUMBER | LEAD FINISH |
|-------------|----------------------------------|
| Blank | NiPdAu |
| F | NiPdAu (Pb-free, RoHS compliant) |

| PART NUMBER | TEMPERATURE RANGE | FLOW | BURN IN |
|-------------|-------------------|------|---------|
| I | -40°C TO +85°C | I | NO |
| T | -55°C TO +125°C | T | NO |

| PART NUMBER | PACKAGE DESCRIPTION |
|-------------|-------------------------------------|
| PC | 16 PIN PLASTIC 4 x 4 mm QFN (16PCS) |

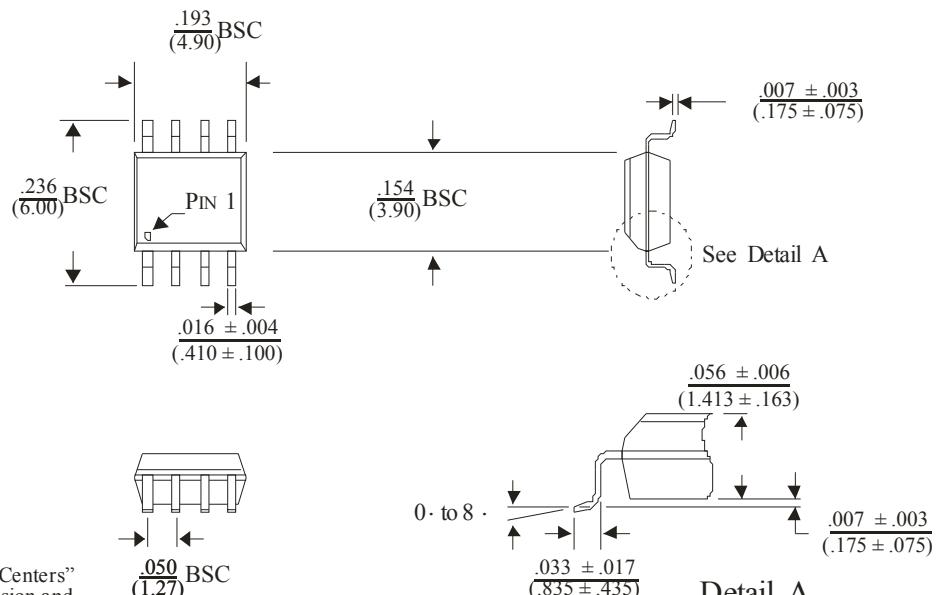
| PART NUMBER | FUNCTION |
|-------------|--|
| 4855 | FULL DUPLEX TRANSCEIVER WITH ENABLE PINS |

REVISION HISTORY

| Revision | Date | Description of Change |
|-----------------|-------------|--|
| DS4853, Rev New | 03/30/2012 | Initial Release |
| Rev. A | 05/21/2012 | Fix typos on package ordering information |
| Rev. B | 08/2/2012 | Updated Rx Function Table rows 2 and 3 on p. 2 for DE = X. Updated package drawings for SOIC-8 (8HN), QFN-16 (16PCS) and SOIC-14 (14HN) packages. |
| Rev. C | 02/25/2013 | Correct typo on nRE pull-up resistor (should be pull-down). Update Digital Input pull-up/pull-down current. Update typo in Figure 4 resistors. Update solder temperature (reflow) in Max. Ratings |
| Rev. D | 04/24/2019 | Correct typo in QFN package drawing. Remove redundant Control Input Voltages from Absolute Maximum Ratings (same parameter as Digital Input Voltages). Update QFN lead finish to NiPdAu. |

**8-PIN PLASTIC SMALL OUTLINE (SOIC) - NB
(Narrow Body)**

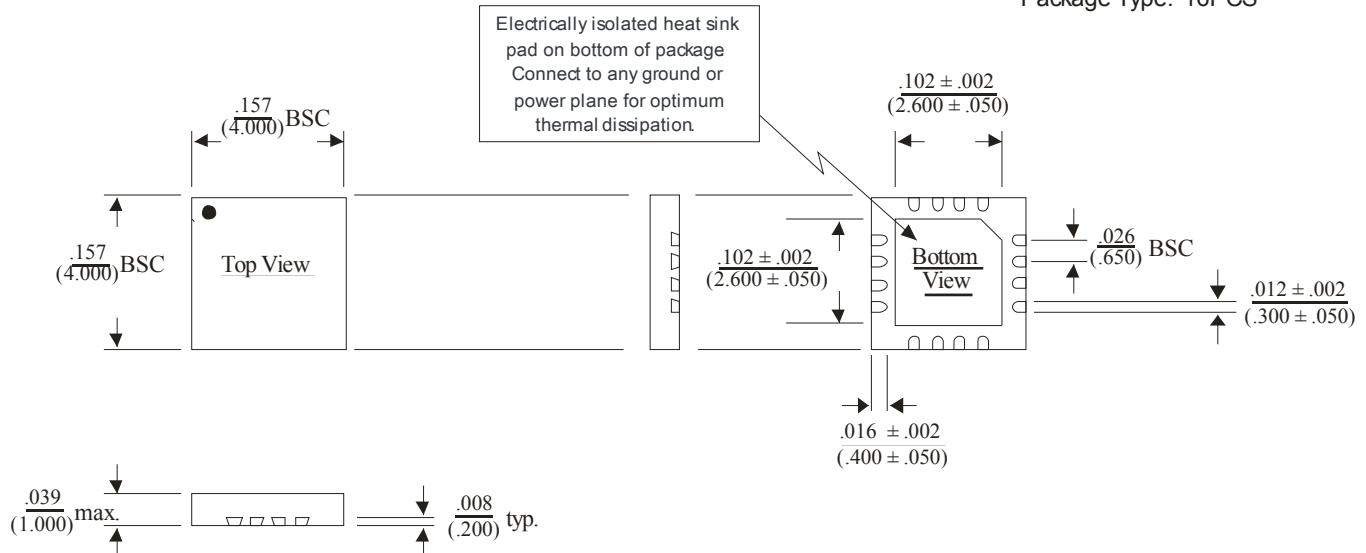
inches (millimeters)
Package Type: 8HN



BSC = "Basic Spacing between Centers" is the theoretical true position dimension and has no tolerance. (EDEC Standard 95)

16-PIN PLASTIC CHIP-SCALE PACKAGE

inches (millimeters)
Package Type: 16PCS

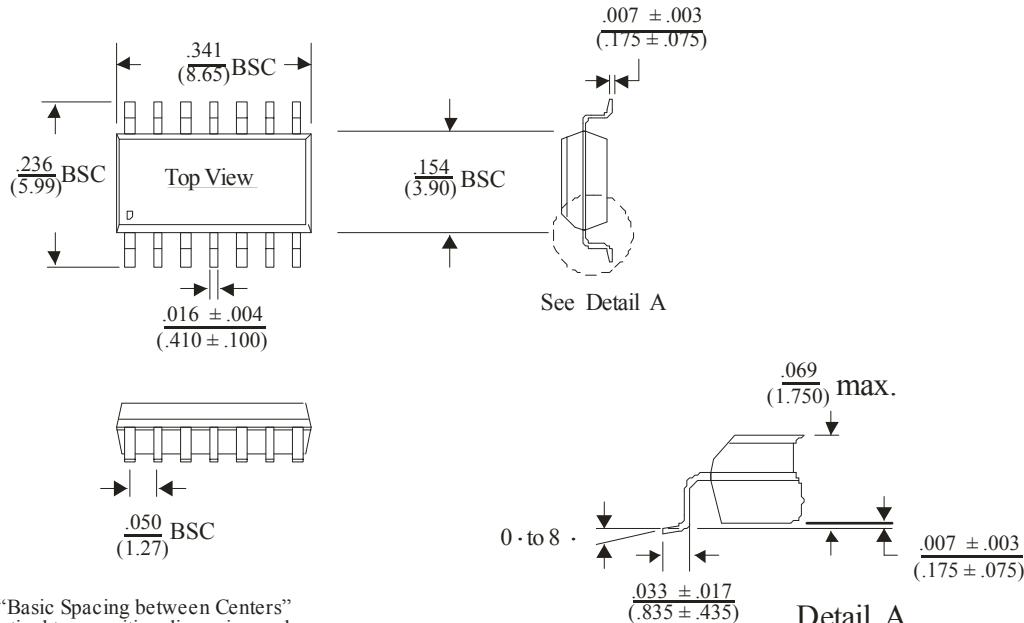


BSC = "Basic Spacing between Centers" is the theoretical true position dimension and has no tolerance. (EDEC Standard 95)

14-PIN PLASTIC SMALL OUTLINE (SOIC) - NB (Narrow Body)

inches (millimeters)

Package Type: 14HN

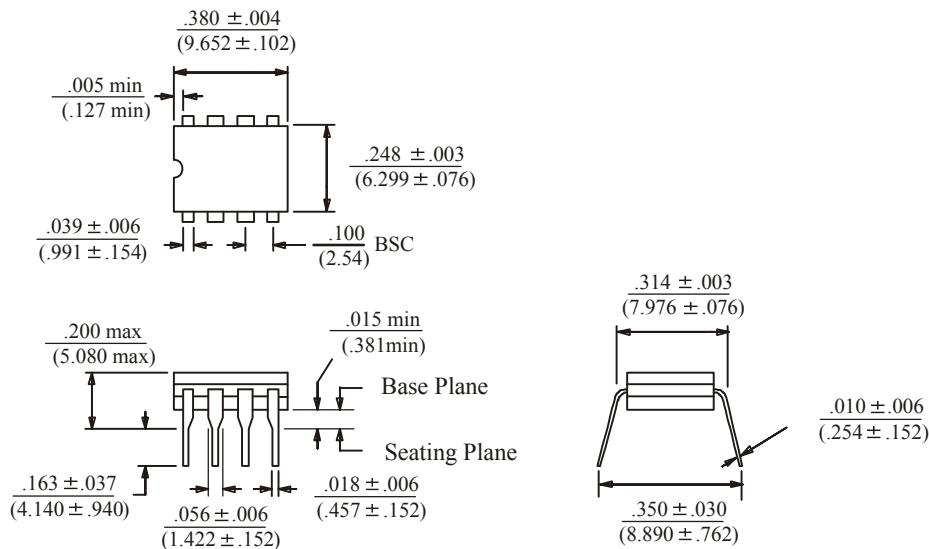


BSC = "Basic Spacing between Centers" is theoretical true position dimension and has no tolerance. (JEDEC Standard 95)

8-PIN CERDIP

inches (millimeters)

Package Type: 8D



BSC = "Basic Spacing between Centers" is theoretical true position dimension and has no tolerance. (JEDEC Standard 95)